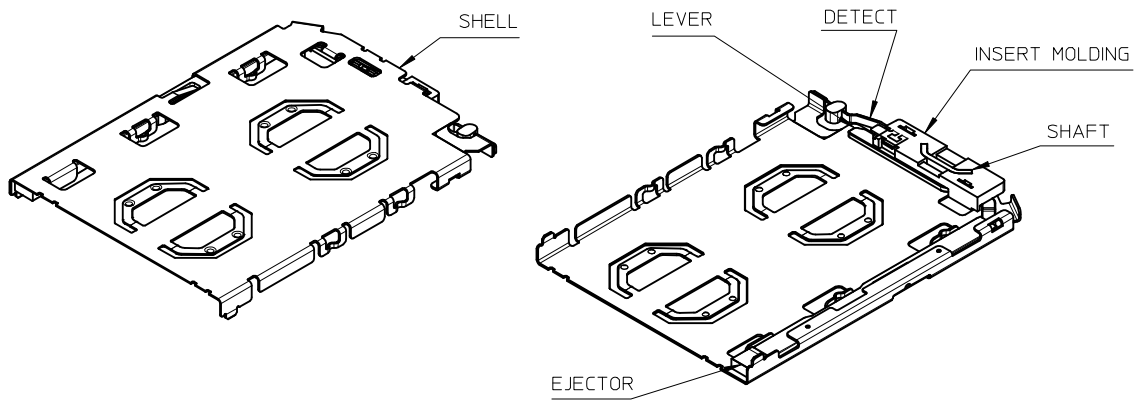
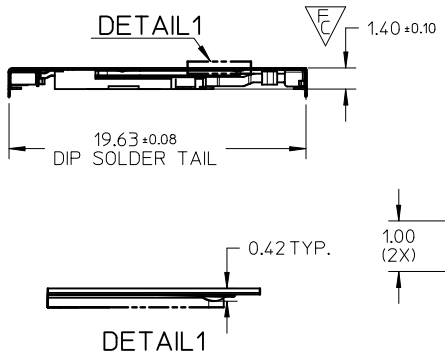
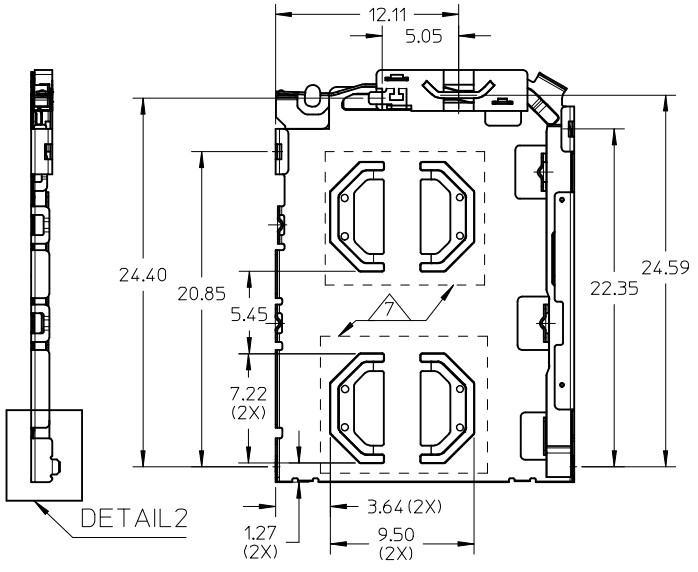
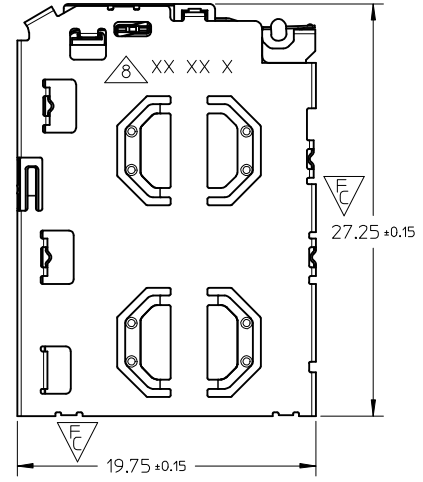


10 9 8 7 6 5 4 3 2 1

THIS DESIGN IS BASED ON DESIGN OBJECTIVES AND IS STRICTLY TENTATIVE. IT MAY CHANGE BASED ON RESULTS OF ADDITIONAL DESIGN REVIEWS & VERIFICATIONS.



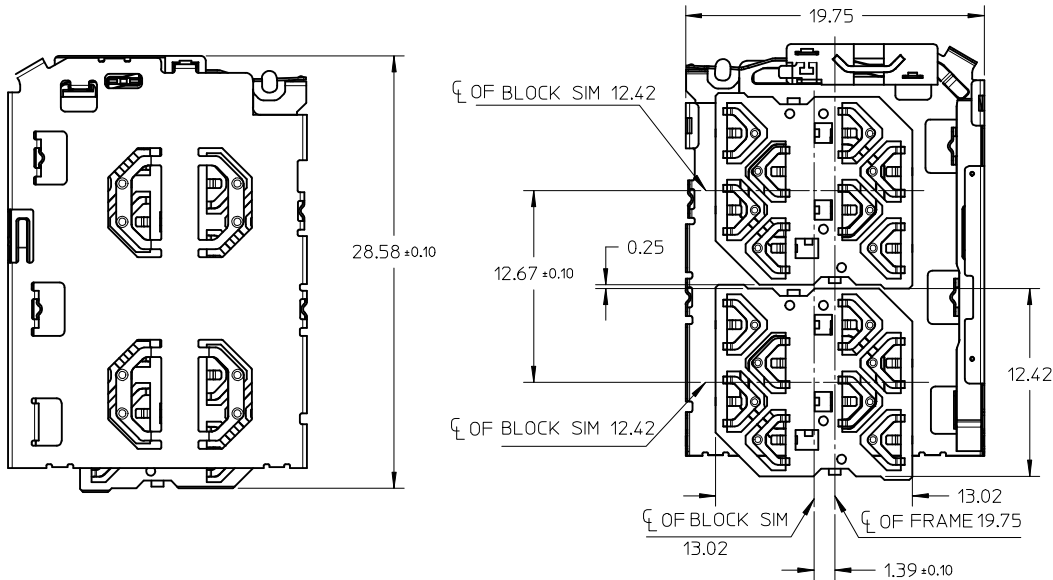
- NOTES:
- MATERIALS:
 INSERT MOLD HOUSING: LCP, UL94V-0;
 LEVER, SHAFT, EJECTOR, SHELL: STAINLESS STEEL;
 DETECT SPRING: COPPER ALLOY;
 - FINISHES:
 DETECT SPRING:
 1.27um MIN. NICKEL UNDERPLATING OVERALL;
 0.127um MIN. GOLD PLATING ON CONTACT AREA;
 1.27 um MIN. TIN PLATING ON SOLDERING TAIL;
 SHELL:
 1.27um MIN NICKEL UNDERPLATING OVERALL;
 0.025um MIN GOLD PLATING ON CONTACT AREA AND SOLDERING AREA;
 SHAFT: 1.27um MIN TIN ON SOLDERING TAIL;
 - PRODUCT SPECIFICATION: PS-151031-001;
 - PACKAGING SPECIFICATION: PK-151031-001;PK-151032-001
 - SOLDER TAIL COPLANARITY: 0.10 MM MAX BEFORE REFLOW
 - THIS PART IS A FRAME ONLY, IT SHOULD BE USED TOGETHER WITH 0.35MM BLOCK SIM 151032 FOR AN ENTIRE SIM POP OUT SYSTEM;
 - 0.10 MINIMUM KEEP OUT ZONE FROM TOP SURFACE OF SHELL DURING INSERTION AND WITHDRAWAL OF TRAY (WITH SIM CARD)
 - DATE CODE PRINTED: XX XX X
 DAY
 WEEK
 YEAR



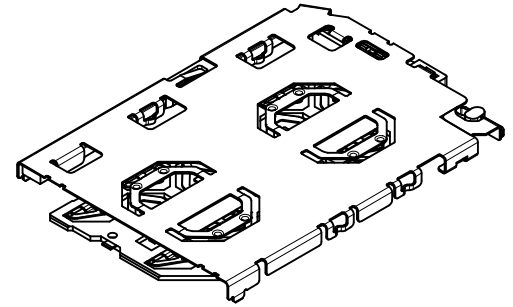
CHANGE BLOCK SIM AND TRAY EC NO: S2014-0434 DRWN: JZENG 2013/11/04 CHKD: JTAN02 2014/01/02 APPR: KHL IM 2014/01/27	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE NTS	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION	
	$F_A=0$	mm	INCH	DRAWN BY	DATE	TITLE			
	$F_C=4$	4 PLACES ± --- ± ---	JZENG 2013/11/04	DUAL MICRO SIM FRAME					
	$F_B=0$	3 PLACES ± --- ± ---	CHECKED BY	DATE	1.40 H				
	2 PLACES ± 0.20 ± ---	JTAN02 2013/12/05	APPROVED BY						
	1 PLACE ± 0.20 ± ---	KHL IM 2014/01/27	DATE						
	0 PLACE ± --- ± ---	ANGULAR ± 3 °		MATERIAL NO.		DOCUMENT NO.		SHEET NO.	
	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	SIZE A3		1510310001		SD-151031-0001		1 OF 5	
		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION							

9 8 7 6 5 4 3 2 1

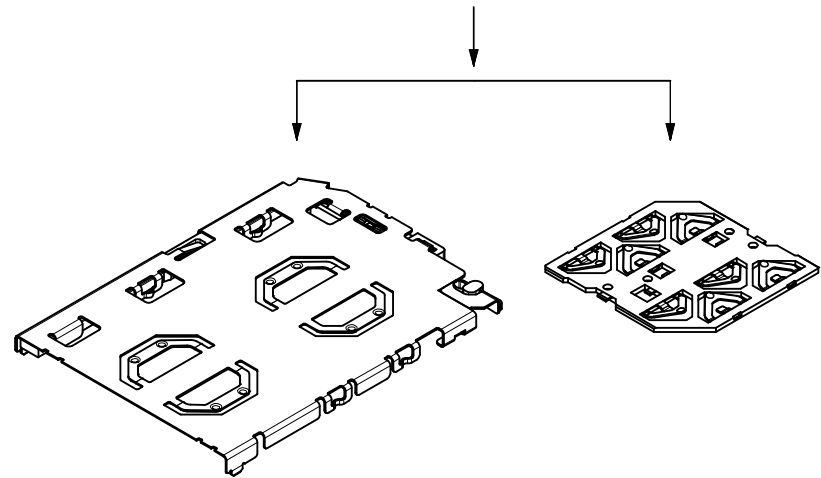
SIM CONNECTOR
(WITH 151032 BLOCK SIM CONNECTOR)



SIM CONNECTOR BOM



FRAME + BLOCK SIM



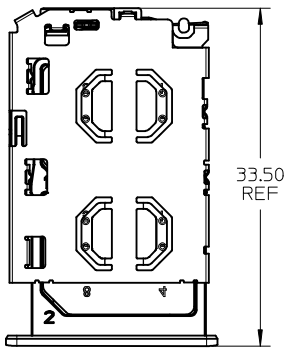
151031 SERIES

151032 SERIES

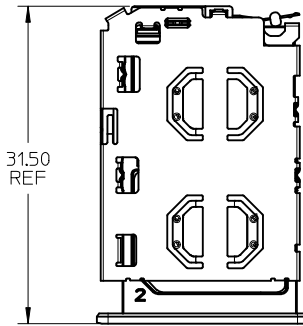
THIS DESIGN IS BASED ON DESIGN OBJECTIVES AND IS STRICTLY TENTATIVE. IT MAY CHANGE BASED ON RESULTS OF ADDITIONAL DESIGN REVIEWS & VERIFICATIONS.

SEE SHEET 1 EC NO: S2014-0434 2013/11/04 DRWN: JZENG 2014/01/02 CHKD: JTAN02 APPR: KHL IM 2014/01/27	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)	DIMENSION STYLE	SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION
	$F_A=0$ $F_B=0$ $F_C=0$	mm INCH 4 PLACES ± --- ± --- 3 PLACES ± --- ± --- 2 PLACES ± 0.20 ± --- 1 PLACE ± 0.20 ± --- 0 PLACE ± --- ± ---	MM ONLY	NTS	METRIC	TITLE DUAL MICRO SIM FRAME 1.40 H
	DESCRIPTION	ANGULAR ± 3 °	DRAWN BY	DATE	TITLE	molex DOCUMENT NO. SD-151031-0001 SHEET NO. 2 OF 5
	REV	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	JZENG	2013/11/04	CHECKED BY	
					JTAN02	2013/12/05
					APPROVED BY	
					KHL IM	2014/01/27
				MATERIAL NO.		
				1510310001		

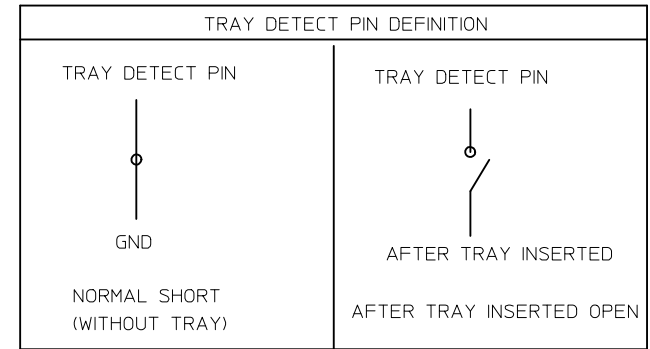
SIM CONNECTOR FRAME AND TRAY



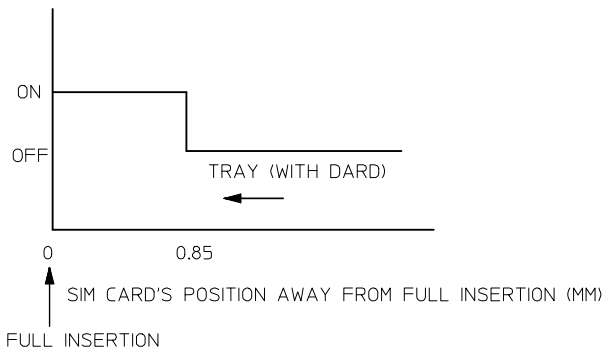
TRAY EJECTED POSITION



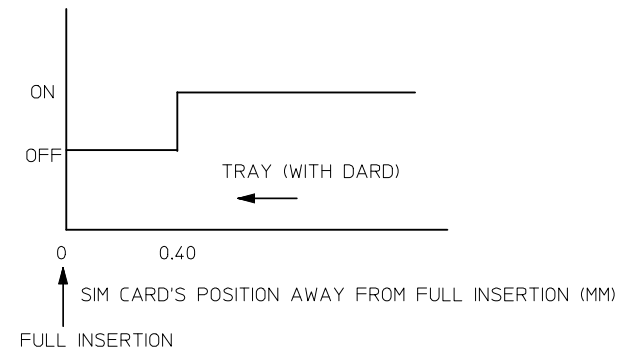
TRAY INSERTION POSITION



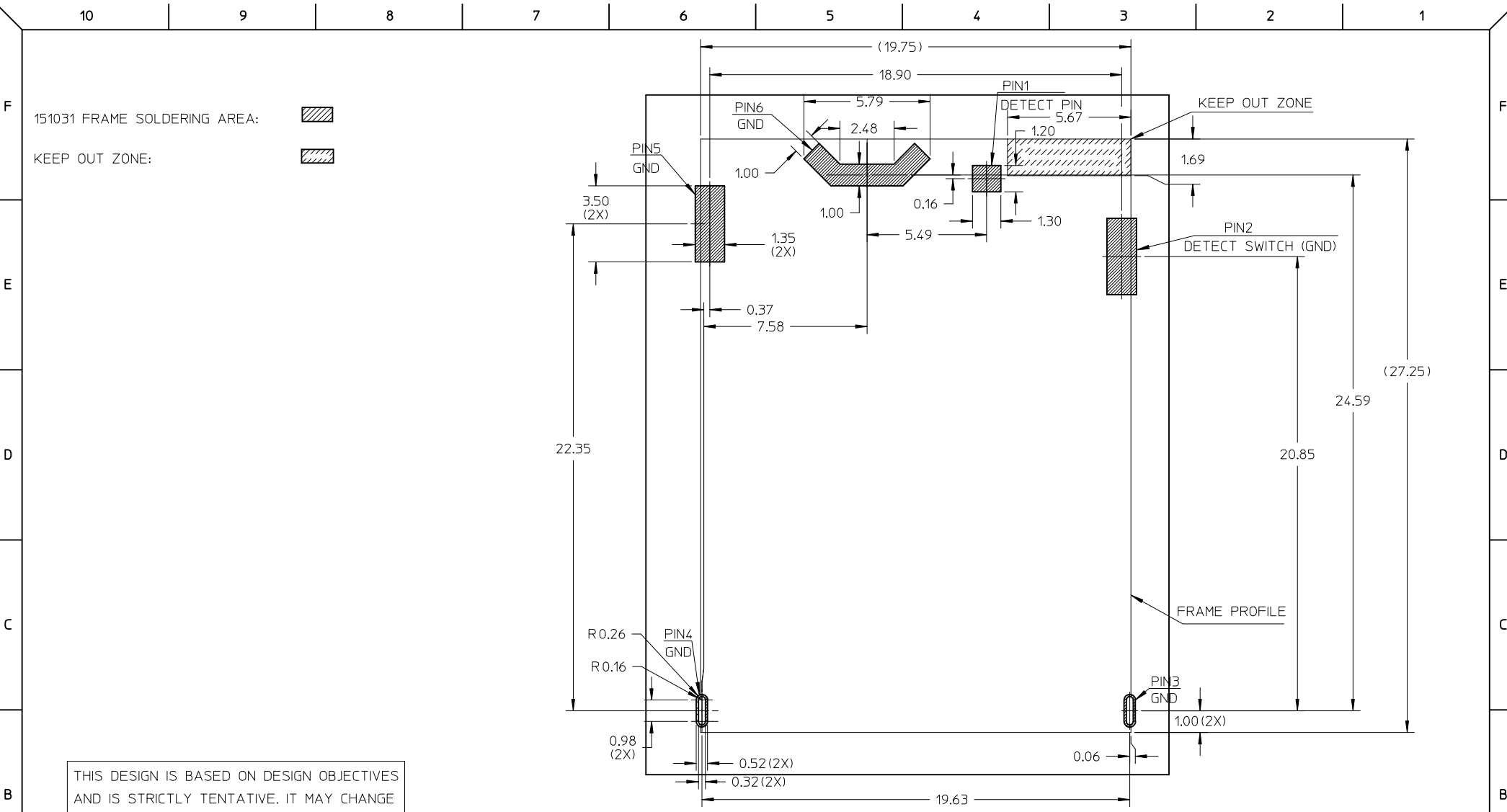
SIGNAL PIN



DETECT SWITCH PIN






ENTER DESCRIPTION EC NO: S2014-0434 DRWN: JZENG CHKD: JTAN02 APPR: KHL IM	DESCRIPTION 2013/11/04 2014/01/02 2014/01/27	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE	SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION
		$F_A=0$ $F_G=0$ $F_P=0$	mm	INCH	MM ONLY		METRIC	
			4 PLACES	± ---	± ---	DRAWN BY	DATE	TITLE
			3 PLACES	± ---	± ---	JZENG	2013/11/04	DUAL MICRO SIM FRAME 1.40 H
	2 PLACES	± 0.20	± ---	CHECKED BY	DATE			
	1 PLACE	± 0.20	± ---	JTAN02	2013/12/05			
	0 PLACE	± ---	± ---	APPROVED BY	DATE			
				KHL IM	2014/01/27			
				MATERIAL NO.		DOCUMENT NO.	SHEET NO.	
				1510310001		SD-151031-0001	3 OF 5	
				SIZE	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION			
				A3				

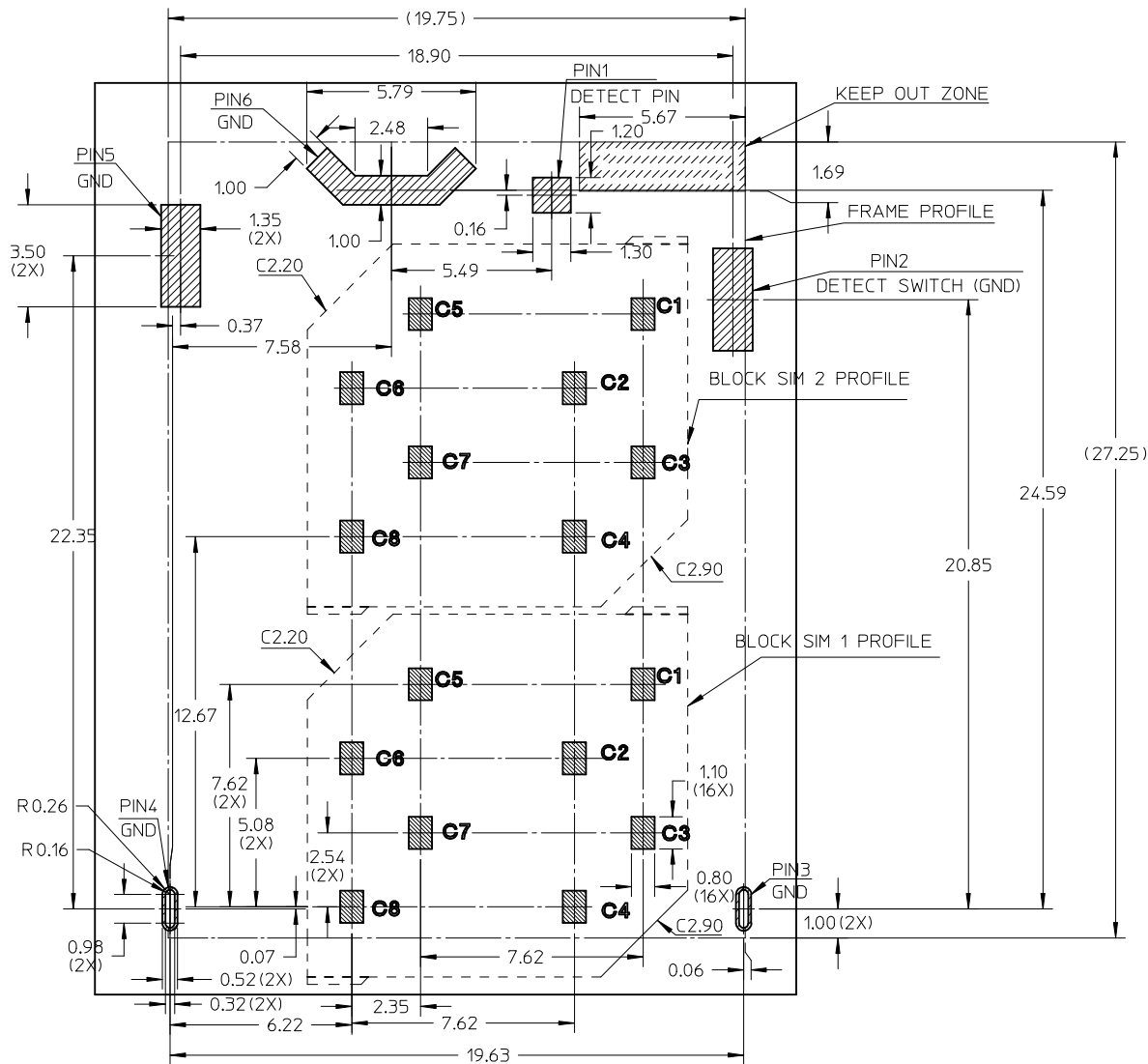


THIS DESIGN IS BASED ON DESIGN OBJECTIVES AND IS STRICTLY TENTATIVE. IT MAY CHANGE BASED ON RESULTS OF ADDITIONAL DESIGN REVIEWS & VERIFICATIONS.

RECOMMENDED PCB LAYOUT: TOLERANCE ±0.05
 RECOMMENDED PCB THICKNESS: 0.80MM
 RECOMMENDED STENCIL THICKNESS: 0.10MM

SEE SHEET 1 EC NO: S2014-0434 DRWN: JZENG CHKD: JTAN02 APPR: KHL IM	2013/11/04 2014/01/02 2014/01/27	QUALITY SYMBOLS $F_A=0$ $F_C=0$ $F_P=0$	GENERAL TOLERANCES (UNLESS SPECIFIED) mm INCH 4 PLACES ± --- ± --- 3 PLACES ± --- ± --- 2 PLACES ± 0.20 ± --- 1 PLACE ± 0.20 ± --- 0 PLACE ± --- ± --- ANGULAR ± 3 ° DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	DIMENSION STYLE MM ONLY DRAWN BY: JZENG CHECKED BY: JTAN02 APPROVED BY: KHL IM MATERIAL NO: 1510310001	SCALE: NTS DESIGN UNITS: METRIC THIRD ANGLE PROJECTION TITLE: DUAL MICRO SIM FRAME 1.40 H molex DOCUMENT NO: SD-151031-0001	DATE: 2013/11/04 DATE: 2013/12/05 DATE: 2014/01/27 SHEET NO: 4 OF 5
	7	REV		SIZE: A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION	

151031 FRAME SOLDERING AREA: 
 151032 BLOCK SIM SOLDERING AREA: 
 KEEP OUT ZONE: 



THIS DESIGN IS BASED ON DESIGN OBJECTIVES AND IS STRICTLY TENTATIVE. IT MAY CHANGE BASED ON RESULTS OF ADDITIONAL DESIGN REVIEWS & VERIFICATIONS.

RECOMMENDED PCB LAYOUT: TOLERANCE ±0.05
 RECOMMENDED PCB THICKNESS: 0.80MM
 RECOMMENDED STENCIL THICKNESS: 0.10MM

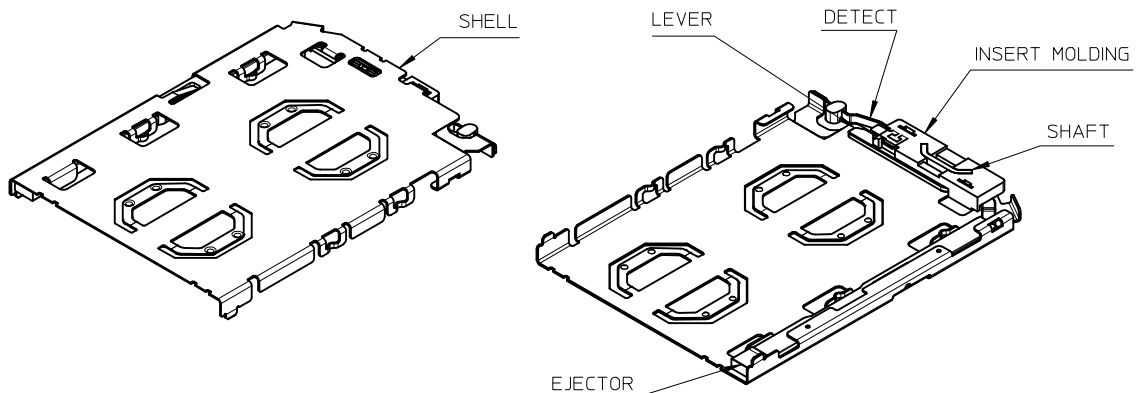
SEE SHEET 1 EC NO: S2014-0434 DRWN: JZENG CHKD: JTAN02 APPR: KHLIM	2013/11/04 2014/01/02 2014/01/27	DESCRIPTION REV 7	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)	DIMENSION STYLE	SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION
			$F_A=0$ $F_C=0$ $F_P=0$	mm INCH 4 PLACES ± --- ± --- 3 PLACES ± --- ± --- 2 PLACES ± 0.20 ± --- 1 PLACE ± 0.20 ± --- 0 PLACE ± --- ± ---	MM ONLY	NTS	METRIC	
			ANGULAR ± 3 ° DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	DRAWN BY: JZENG DATE: 2013/11/04 CHECKED BY: JTAN02 DATE: 2013/12/05 APPROVED BY: KHLIM DATE: 2014/01/27	TITLE			DUAL MICRO SIM FRAME 1.40 H
			MATERIAL NO. 1510310001	DOCUMENT NO. SD-151031-0001	SHEET NO.		5 OF 5	

molex

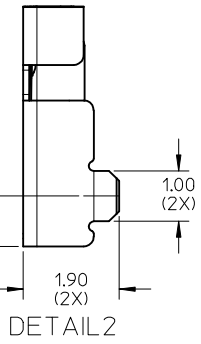
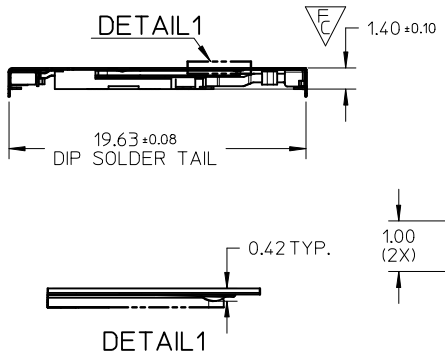
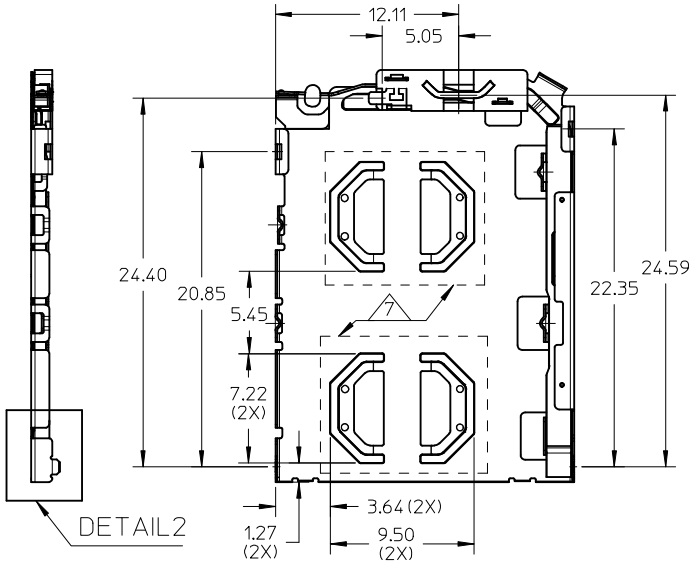
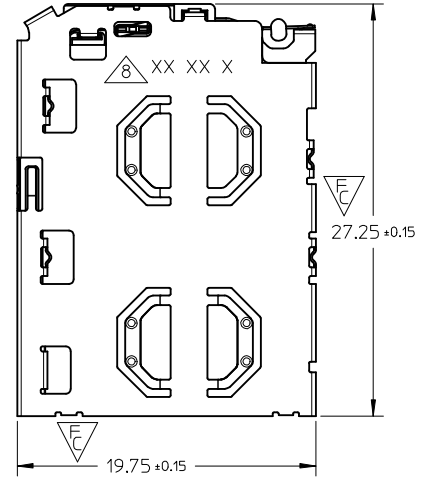
THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION

10 9 8 7 6 5 4 3 2 1

THIS DESIGN IS BASED ON DESIGN OBJECTIVES AND IS STRICTLY TENTATIVE. IT MAY CHANGE BASED ON RESULTS OF ADDITIONAL DESIGN REVIEWS & VERIFICATIONS.



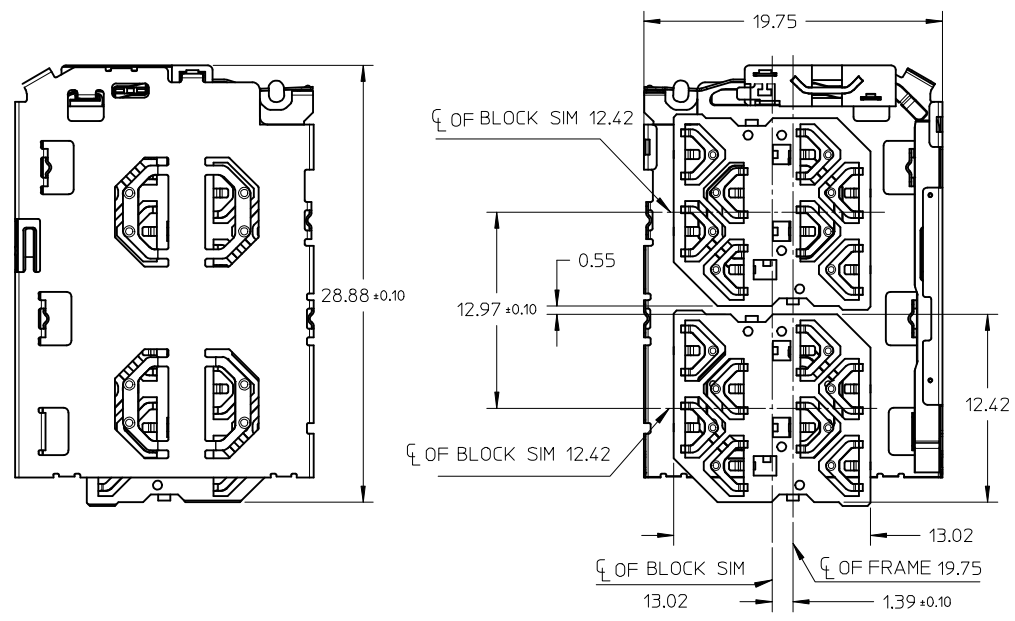
- NOTES:
- MATERIALS:
INSERT MOLD HOUSING: LCP, UL94V-0;
LEVER, SHAFT, EJECTOR, SHELL: STAINLESS STEEL;
DETECT SPRING: COPPER ALLOY;
 - FINISHES:
DETECT SPRING:
1.27um MIN. NICKEL UNDERPLATING OVERALL;
0.127um MIN. GOLD PLATING ON CONTACT AREA;
1.27 um MIN. TIN PLATING ON SOLDERING TAIL;
SHELL:
1.27um MIN NICKEL UNDERPLATING OVERALL;
0.025um MIN GOLD PLATING ON CONTACT AREA AND SOLDERING AREA;
SHAFT: 1.27um MIN TIN ON SOLDERING TAIL;
 - PRODUCT SPECIFICATION: PS-151031-001;
 - PACKAGING SPECIFICATION: PK-151031-001;PK-151032-001
 - SOLDER TAIL COPLANARITY: 0.10 MM MAX BEFORE REFLOW
 - THIS PART IS A FRAME ONLY, IT SHOULD BE USED TOGETHER WITH 0.35MM BLOCK SIM 151032 FOR AN ENTIRE SIM POP OUT SYSTEM;
 - 0.10 MINIMUM KEEP OUT ZONE FROM TOP SURFACE OF SHELL DURING INSERTION AND WITHDRAWAL OF TRAY (WITH SIM CARD)
 - DATE CODE PRINTED: XX XX X
 - DAY
 - WEEK
 - YEAR



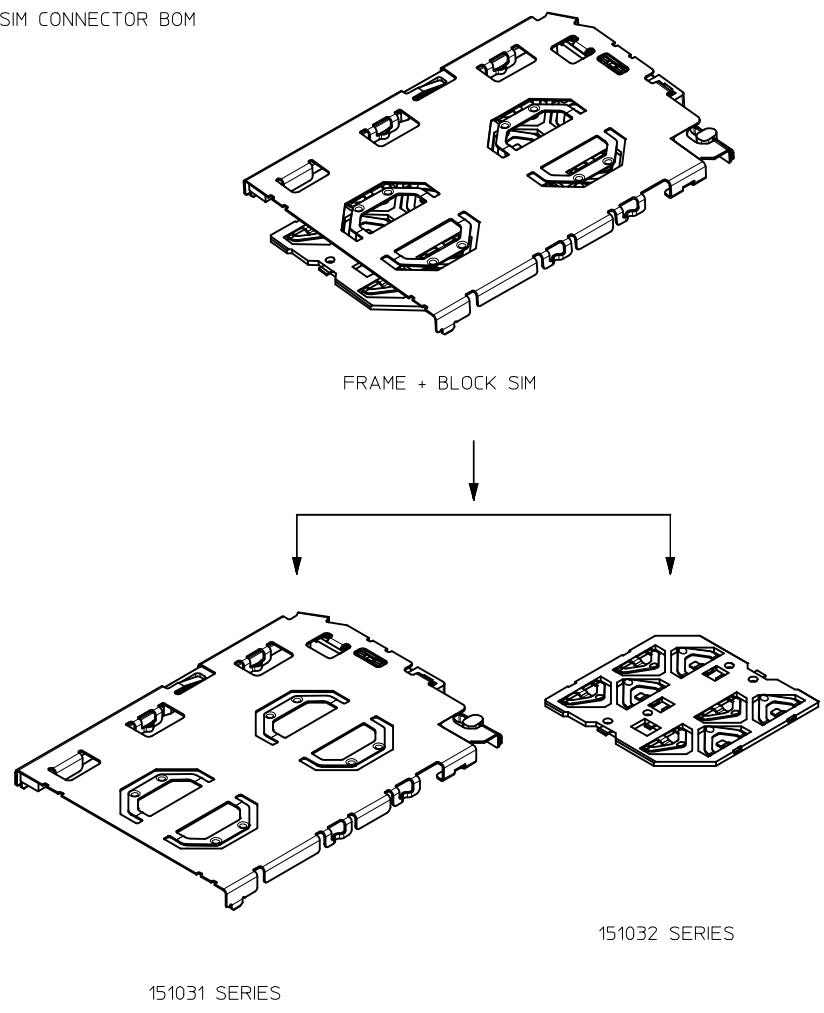
UPDATED DRAWING EC NO: S2014-0434 DRWN: JZENG 2013/12/13 CHKD: JTAN02 2014/01/02 APPR: KHLIM 2014/01/27	QUALITY SYMBOLS F _A =0 F _C =4 F _P =0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE	SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION	
				MM ONLY	NTS	METRIC		
				DRAWN BY	DATE	TITLE		
				CHECKED BY	DATE	DUAL MICRO SIM FRAME 1.40H		
		APPROVED BY		DATE				
		KHLIM		2014/01/27				
		MATERIAL NO.		DOCUMENT NO.	SHEET NO.			
		1510310001		SD-151031-0002	1 OF 4			
		SIZE		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				
		A3						

9 8 7 6 5 4 3 2 1

SIM CONNECTOR
(WITH 151032 BLOCK SIM CONNECTOR)



SIM CONNECTOR BOM



THIS DESIGN IS BASED ON DESIGN OBJECTIVES AND IS STRICTLY TENTATIVE. IT MAY CHANGE BASED ON RESULTS OF ADDITIONAL DESIGN REVIEWS & VERIFICATIONS.

SEE SHEET 1 EC NO: S2014-0434 DRWN: JZENG CHKD: JIAN02 APPR: KHL IM	2013/12/13	DESCRIPTION	QUALITY SYMBOLS
	2014/01/02		$\nabla_A = 0$
	2014/01/27		$\nabla_C = 0$
			$\nabla_P = 0$

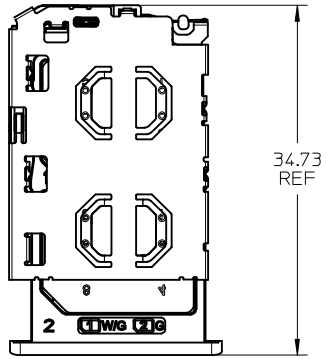
GENERAL TOLERANCES (UNLESS SPECIFIED)	
	mm INCH
4 PLACES	± --- ± ---
3 PLACES	± --- ± ---
2 PLACES	± 0.20 ± ---
1 PLACE	± 0.20 ± ---
0 PLACE	± --- ± ---
ANGULAR ± 3 °	
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	

DIMENSION STYLE MM ONLY	
DRAWN BY JZENG	DATE 2013/12/13
CHECKED BY	DATE
APPROVED BY KHL IM	DATE 2014/01/27
MATERIAL NO. 1510310001	
SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION

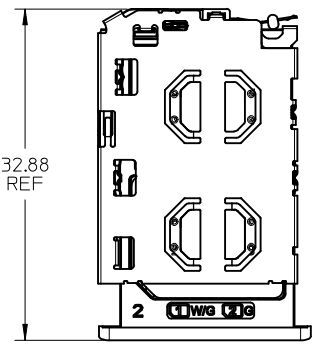
SCALE NTS	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION
TITLE DUAL MICRO SIM FRAME 1.40H		
DOCUMENT NO. SD-151031-0002		SHEET NO. 2 OF 4



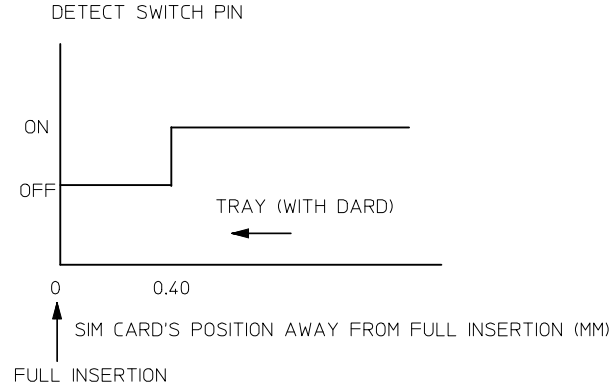
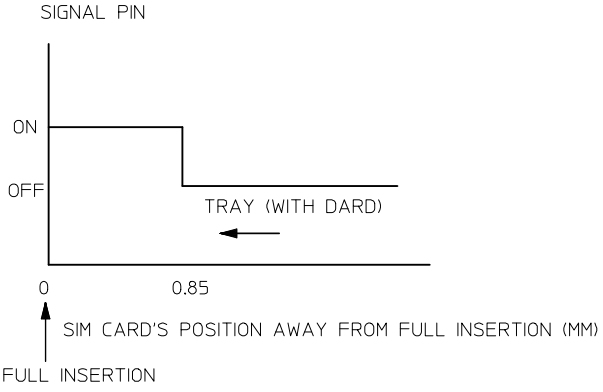
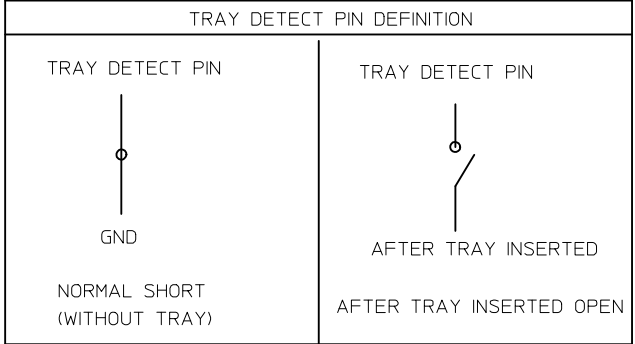
SIM CONNECTOR FRAME AND TRAY






TRAY EJECTED POSITION

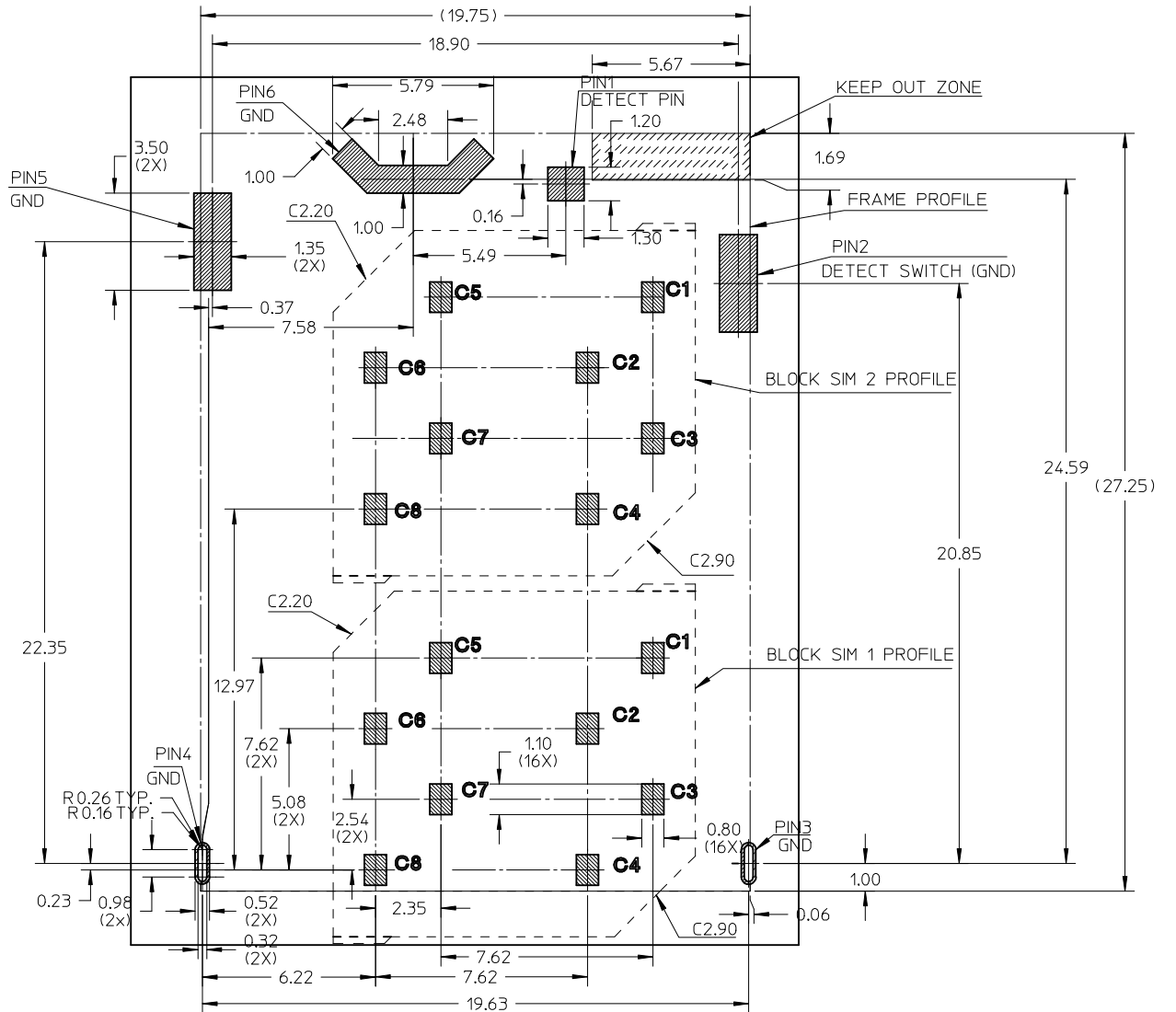


TRAY INSERTION POSITION




SEE SHEET 1 EC NO: S2014-0434 DRWN: JZENG CHKD: JIAN02 APPR: KHL IM	2013/12/13 2014/01/02 2014/01/27	DESCRIPTION QUALITY SYMBOLS $F_A=0$ $F_G=0$ $F_P=0$	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE	SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION			
					MM ONLY						
				mm	INCH	DRAWN BY	DATE	TITLE			
				4 PLACES	± ---	± ---	JZENG	2013/12/13	DUAL MICRO SIM FRAME 1.40H		
	3 PLACES	± ---	± ---	CHECKED BY	DATE						
	2 PLACES	± 0.20	± ---	APPROVED BY	DATE						
	1 PLACE	± 0.20	± ---	KHL IM	2014/01/27	MATERIAL NO.		DOCUMENT NO.	SHEET NO.		
	0 PLACE	± ---	± ---	ANGULAR ± 3 °		1510310001		SD-151031-0002	3 OF 4		
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS			SIZE	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION							
			A3								

151031 FRAME SOLDERING AREA: 
 151032 BLOCK SIM SOLDERING AREA: 
 KEEP OUT ZONE: 



THIS DESIGN IS BASED ON DESIGN OBJECTIVES AND IS STRICTLY TENTATIVE. IT MAY CHANGE BASED ON RESULTS OF ADDITIONAL DESIGN REVIEWS & VERIFICATIONS.

RECOMMENDED PCB LAYOUT: TOLERANCE ±0.05
 RECOMMENDED PCB THICKNESS: 0.80MM
 RECOMMENDED STENCIL THICKNESS: 0.10MM

SEE SHEET 1 EC NO: S2014-0434 DRWN: JZENG CHKD: JTAN02 APPR: KHL IM	2013/12/13 2014/01/02 2014/01/27	DESCRIPTION	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)	DIMENSION STYLE	SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION
			$F_A = 0$ $F_C = 0$ $F_P = 0$	mm INCH 4 PLACES ± --- ± --- 3 PLACES ± --- ± --- 2 PLACES ± 0.20 ± --- 1 PLACE ± 0.20 ± --- 0 PLACE ± --- ± ---	MM ONLY	NTS	METRIC	
			ANGULAR ± 3 ° DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	DRAWN BY: JZENG CHECKED BY: KHL IM APPROVED BY: KHL IM	DATE: 2013/12/13 DATE: 2014/01/27	TITLE: DUAL MICRO SIM FRAME 1.40H		
			MATERIAL NO: 1510310001 SIZE: A3 THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION	DOCUMENT NO: SD-151031-0002 SHEET NO: 4 OF 4				

Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



Тел: +7 (812) 336 43 04 (многоканальный)
Email: org@lifeelectronics.ru